









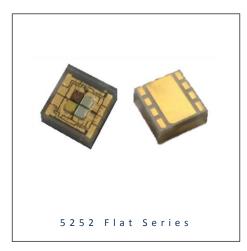
PRODUCT DATASHEET



- ► Ceramic High Power
- ► 5252 Flat 1.3t Series
- ► Cool White / Red / Green / Blue

NOM19S93





5252 Flat Series





FEATURES (White/Red/Green/Blue*):

Package: Ceramic SMT Package with Silicon Lens

Forward Current: 350/350/350/350mA Forward Voltage (typ.): 3.1/2.0/3.2/3.1V

Luminous Flux (typ.): 95/35/60/22Im @350mA

Colour: Cool White/Red/Green/Blue

CCT/Wavelength: 6500K/625/520/460nm

Viewing angle: 135/135/135°

Materials:

Die: InGaN/AlGaInP/InGaN/InGaN

Resin: Silicon (Water Clear)

Operating Temperature: -40~+85°C

Storage Temperature: -40~+100°C

ESD: 2000V (HBM: MIL-STD-883 Class 2)

Grouping parameters:

Forward voltage

Luminous flux

CCT/Wavelength

Soldering methods: IR Reflow soldering

Preconditioning: MSL 2 according to J-STD020

Packing: 12mm tape Max. 500pcs/reel, ø180mm (7")

APPLICATIONS:

- **Decoration Lighting**
- Wall Washer
- Spot Light
- **Outdoor Lighting**
- Mini Projector

Release Date: 09 November 2015 Version: A1.0



CHARACTERISTICS:

Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
Forward Current	I _F	350/350/350/350*	mA
Maximum Forward Current	I _{MAX}	700/700/700/700	mA
Pulse Current D=0.01s Duty 1/10	I _{FP}	1200/1200/1200/1200	mA
Reverse Voltage	V _R	-5	V
Reverse Current @5V	I _R	10	μΑ
Electrostatic Discharge (HBM)	ESD	2000	V
Junction Temperature	Tj	125	°C
Thermal Resistance	R _{TH}	2.5~4	°C/W
Soldering Temperature	T _{sol}	260	°C
Operating Temperature	T _{OPR}	-40~+85	°C
Storage Temperature	T _{STG}	-40~+100	°C

^{1. *} In the order of White/Red/Green/Blue.



Electrical & Optical Characteristics (Ta=25°C)

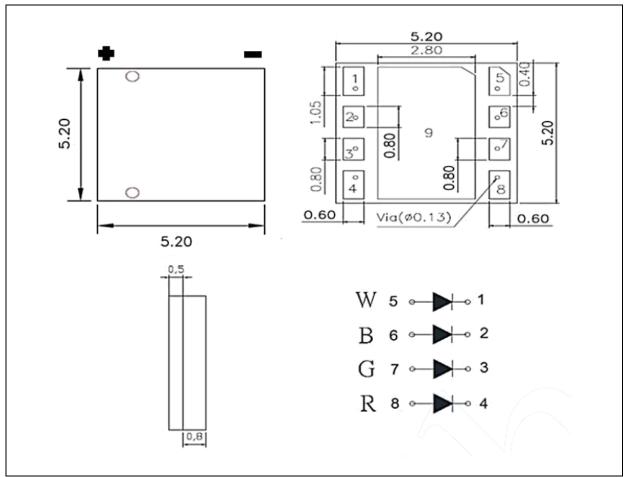
Parameter	Symbol	vmhol				Test
T di di licter	3,111501	Min.	Тур.	Max.	Unit	Condition
White - Forward Voltage	V _F	2.8	3.1	3.6	V	I _F =350mA
White - Luminous Flux	Фу	80	95	110	lm	I _F =350mA
White – Colour Temperature	ССТ	5000	6500	8220	К	I _F =350mA
Red - Forward Voltage	V _F	1.8	2.0	2.6	V	I _F =350mA
Red - Luminous Flux	Фу	20	35	50	lm	I _F =350mA
Red - Wavelength	W _P	620	625	630	nm	I _F =350mA
Green - Forward Voltage	V _F	3.0	3.2	3.8	V	I _F =350mA
Green - Luminous Flux	Фу	40	60	80	lm	I _F =350mA
Green - Wavelength	W _P	515	520	530	nm	I _F =350mA
Blue - Forward Voltage	V _F	2.8	3.1	3.6	V	I _F =350mA
Blue - Luminous Flux	Фу	12	22	30	lm	I _F =350mA
Blue - Wavelength	W _P	450	460	465	nm	I _F =350mA
Viewing Angle	2θ _{1/2}		135		deg	I _F =350mA

^{1.} Luminous intensity (I_V) ±5%, Forward Voltage (V_F) ±0.1V



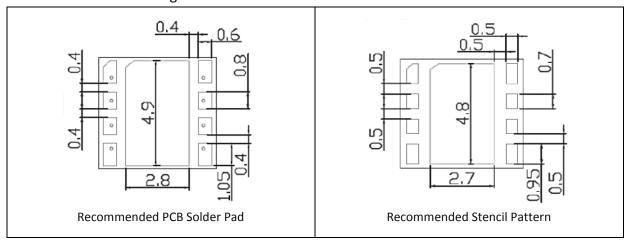
OUTLINE DIMENSION:

Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.1mm, unless otherwise noted.

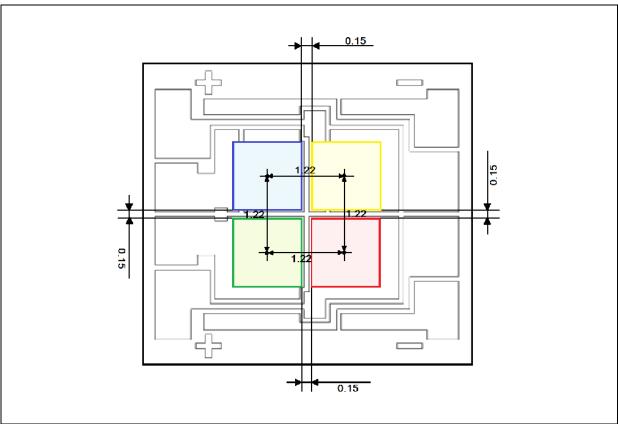
Recommended Soldering Pad Dimension:



- 1. Dimensions are in millimetre (mm).
- 2. Tolerance ± 0.1 mm with angle tolerance ± 0.5 °.



Die Arrangement:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.1mm, unless otherwise noted.



BINNING GROUPS:

Forward Voltage Classifications ($I_F = 350mA$):

Code		Min.	Max.	Unit
	W	2.8	3.6	
\/A	R	1.8	2.6	V
VA	G	3.0	3.8	V
	В	2.8	3.6	

Luminous Flux Classifications ($I_F = 350mA$):

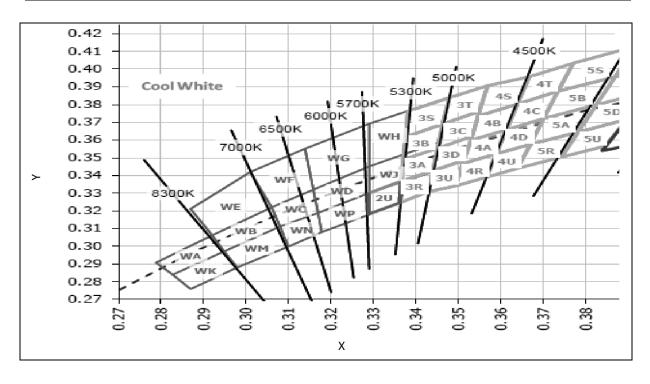
Co	ode	Min.	Max.	Unit
	W	80	110	
1.0	R	20	50	lm
LA	G	40	80	lm lm
	В	12	30	

CCT/Wavelength Classifications (I_F = 350mA):

Со	de	Min.	Max.	Unit
	W	5000	8220	
CD1	R	620	630	1/ /
CB1	G	515	530	K/nm
	B1	450	465	



CIE CHROMATICITY DIAGRAM:

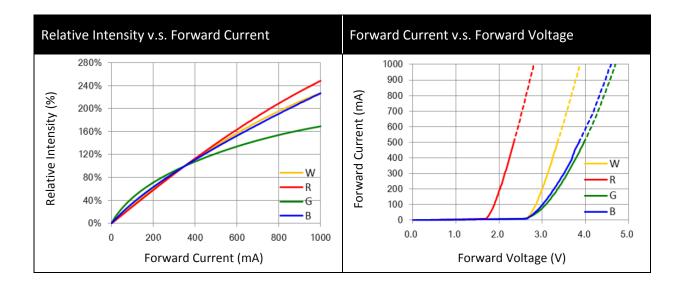


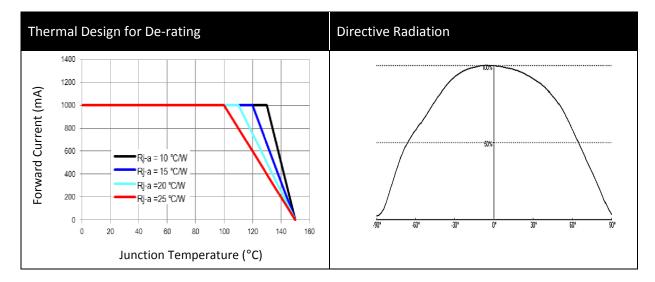
Chromaticity Coordinates Classifications ($I_F = 350 \text{mA}$):

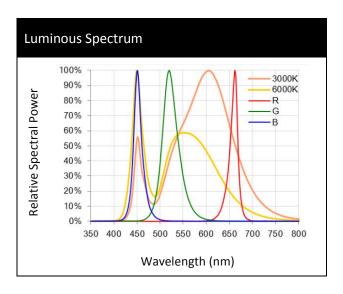
	<u> </u>	1	2		3		4	
	Х	Υ	Х	Υ	Х	Υ	Х	Υ
WE	0.3010	0.3420	0.3060	0.3220	0.2920	0.3060	0.2870	0.3210
WB	0.3060	0.3220	0.3080	0.3110	0.2950	0.2970	0.2920	0.3060
WM	0.3080	0.3110	0.3100	0.3000	0.2980	0.2880	0.2950	0.2970
WF	0.3010	0.3420	0.3060	0.3220	0.3160	0.3320	0.3140	0.3550
WC	0.3160	0.3320	0.3170	0.3190	0.3080	0.3110	0.3060	0.3220
WN	0.3170	0.3190	0.3180	0.3080	0.3100	0.3000	0.3080	0.3110
WG	0.3290	0.3690	0.3290	0.3450	0.3160	0.3320	0.3140	0.3550
WD	0.3290	0.3450	0.3290	0.3300	0.3170	0.3190	0.3160	0.3320
WP	0.3290	0.3300	0.3290	0.3183	0.3180	0.3080	0.3170	0.3190
WH	0.3472	0.3845	0.3449	0.3581	0.3290	0.3450	0.3290	0.3690
WJ	0.3449	0.3581	0.3439	0.3428	0.3290	0.3300	0.3290	0.3450
2U	0.3290	0.3300	0.3366	0.3369	0.3361	0.3245	0.3290	0.3180
3S	0.3381	0.3762	0.3480	0.3840	0.3463	0.3687	0.3376	0.3616
3B	0.3376	0.3616	0.3463	0.3687	0.3451	0.3554	0.3371	0.3490
3A	0.3371	0.3490	0.3451	0.3554	0.3440	0.3427	0.3366	0.3369
3R	0.3366	0.3369	0.3440	0.3428	0.3429	0.3307	0.3361	0.3245



ELECTRO-OPTICAL CHARACTERISTICS:



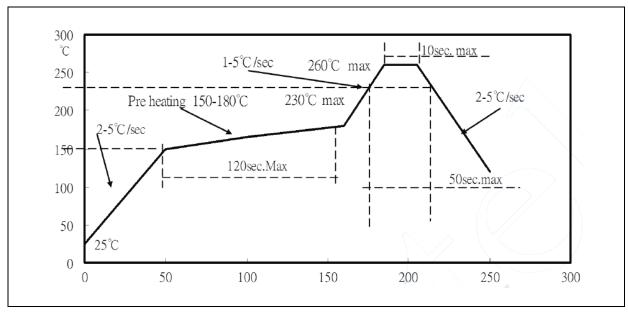






RECOMMENDED SOLDERING PROFILE:

Lead-free Solder:



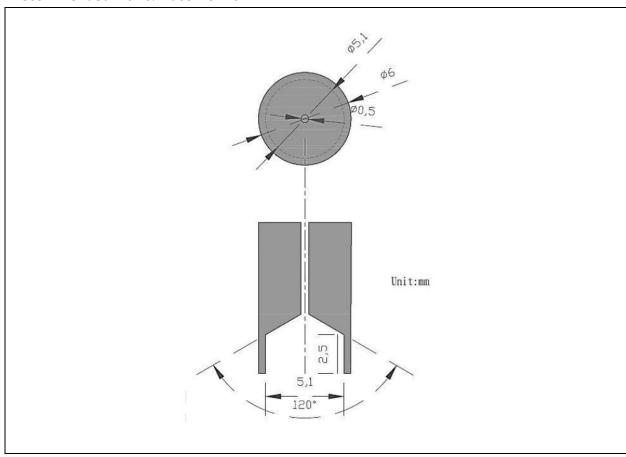
Note:

- 1. Maximum reflow soldering: 3 times.
- 2. The recommended reflow temperature is 240°C. The maximum soldering temperature should be limited to 260°C.
- 3. Before, during, and after soldering, should not apply stress on the components and PCB board.



RECOMMENDED NOZZLE FOR SMT:

Recommended Pick & Place Nozzle:

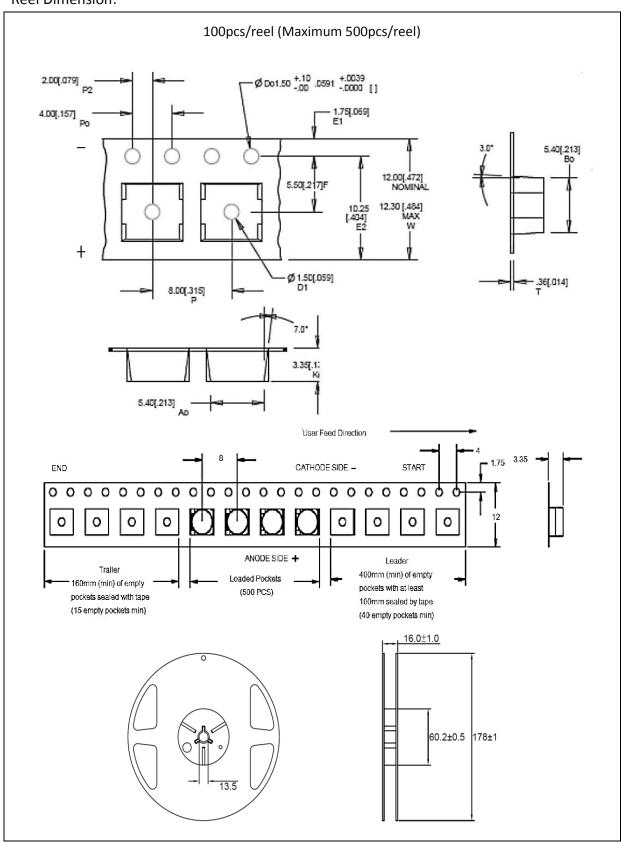


- 1. All dimensions are in millimetre (mm).
- $2. \quad \text{Tolerance ± 0.1mm, unless otherwise noted}.$



PACKING SPECIFICATION:

Reel Dimension:





PRECAUTIONS OF USE:

Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 month at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent and apply baking at 60°C±5°C for 15hrs before use.

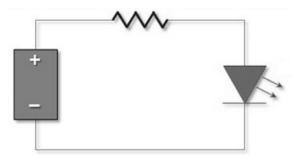
Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

- 70±3°C x 24hrs and <5%RH, taped / reel package.
- 100±3°C x 2hrs, bulk (loose) package.
- 130±3°C x 30min, bulk (loose) package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Testing Circuit:



Must apply resistor(s) for protection (over current proof).

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



REVISION RECORD:

Version	Date	Summary of Revision
A1.0	09/11/2015	Datasheet set-up.